#### Antenna specification

## **Antenna Sample Confirmation From**

Name of supplier	ShenZhen Aihui Technology Co., Ltd						
Customer name		Hua Yi					
Sample name		ML1009P					
model							
Sample size	Three-in-one antenn	09-4G-AH, size 85.89 * 1 a; ML1009-W/g/B-AH, si e 15.1 * 10.25 thimble	-		-		
Inspection item	Performance test	Visual inspection	Structure	In the news	Test results		
Notes							
Quality Audit		Project Audit		Business confirm ation			
The follow	wing is to	be comple <sup>.</sup>	ted by t	he clie	nt		

Customer	
feedback	
Customer	
signature/seal	date:

# **Antenna Test Report**

Test Unit: Sl	nenzhen Aihı	ui Technolog	y Co. , Ltd.			
Materials FPC coaxial line						
Antenna type	MonopoleType	Polarization mode	Linear			
Application						
scenario						
Working band	GSM/LTE/WIFI /BT /GPS	VSWR	≤2			

Power	Max: 2W	Impedance	50Ω
dBi			
Test Equipment	HPE5071C、Shieldir	ng Room、3D automa	tic turntable
2. Need to change th ● Test voltage: ● The RF cable curled.	<b>sing and picture desc</b> <b>e motherboard to ma</b> 3.6V, check the antenn e of the integrated test	-	state and can not be

- 1.Project Image
- 2.Test Fixture
- 3. Antenna matching circuit
- 4.S11 test
- 5. Antenna passive efficiency and gain
- 6. Darkroom test equipment and data
- 7. Schematic diagram of antenna assembly
- 8. Antenna environment handling
- 9. Antenna mass production index
- 10.Structural drawing

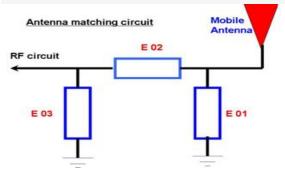
#### 1.Project Image

The final verification antenna performance prototype in our company for at least one year, easy to analyze and solve the problem of antenna mass production, to ensure the quality of antenna shipment

#### 2.Test Fixture

Objective: to test the passive parameters of antenna as accurately as possible. Making Method: the handset is made of a 50 ohm coaxial cable, one end of which is connected to the test point of the back end of the matching circuit of the handset motherboard (front end of the RF test hole), and the other end is connected to the SMA joint. The diagram is as follows:

#### 3、Antenna matching circuit

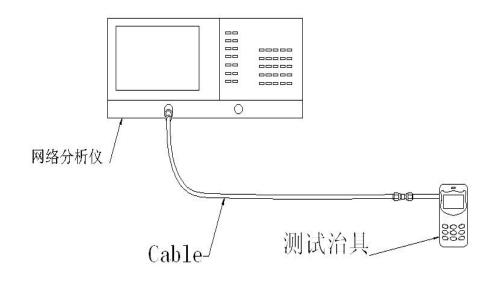


Modify		
E01	E02	E03
No	No	No

Note: The match is unmodified.

#### 4.S11 test

**4.0** 4.0s11 test method description of test equipment: Network Analyzer (E5071C) test method: a 50 ohm CABLE is used to export from the instrument test port. The SMA connector for connecting the handset is calibrated using a calibration piece, record the echo loss and standing wave ratio corresponding to the relevant frequency points. The test schematic is as follows:



# 5. Darkroom test equipment and data

#### LTE:

	diama di successi di succes		1000	
		fficiency 和效率		
frequency 频率(Hz)	gain 增益(dB)	efficiency 效率(dB)	efficiency 效率	
680M	-0.39	-4.54	35.18%	
700M	0.38	-4.18	38.15%	
720M	1.57	-3.38	45.88%	
740M	1.31	- <mark>3.5</mark> 5	44.17%	
760M	0.3	-4.43	36.04%	
780M	-0.18	- <mark>4.</mark> 89	32.4%	
800M	-0.45	-5.55	27.88%	
820M	0.13	-5.26	29.78%	
840M	-0.02	-5.4	28.86%	
860M	-0.33	-5.67	27.12%	
880M	-0.65	-5.82	26.2%	
900M	-0.7	-5.4	28.83%	
920M 960M	-1.25	-5.61 -6.25	27.5%	
980M	-2.02	-6.25	23.69%	
000111	2.04	0.20	20.1170	
2250M	-0.47	-5.12	30.76%	
2284M	-0.58	-4.91	32.28%	
2318M	-0. <b>1</b> 6	- <mark>4</mark> .55	35.07%	
2352M	-0.62	-4. <mark>7</mark> 5	33.5%	
2385M	-1.07	-4.87	32.58%	
2419M	-0.39	-4.28	37.35%	
2453M	0.23	- <mark>4.0</mark> 3	39.57%	
2487M	-0.08	-4.33	36.92%	
2521M	0.23	-3.95	40.24%	
2554M	0.86	-3.9	40.72%	
2588M	1.39	- <mark>4.1</mark> 3	38.65%	
2622M	1.25	-4.23	37.73%	
2656M	0.62	-4.31	37.1%	
2690M	0.83	- <mark>4</mark> .65	34.25%	

Gain&Efficiency 増益和效率						
frequency 频率(Hz)	gain 增益(dB)	efficiency 效率(dB)	efficiency 效率			
1710M	2.94	-4.06	39.24%			
1743M	3.2	-4.07	39.16%			
1777M	3.55	-3.87	40.99%			
1811M	3.66	-4.08	39.1%			
1845M	3.81	-4.27	37.38%			
1878M	3.86	-3.94	40.34%			
1912M	3.73	-3.72	42.45%			
1946M	2.73	-3.94	40.38%			
1980M	2.5	-3.86	41.08%			
2014M	2.64	-3.45	45.19%			
2047M	2.76	-3.65	43.18%			
2081M	2.76	-3.62	43.49%			
2115M	3.2	-3.35	46.28%			
2149M	2.49	-3.8	41.72%			
2183M	0.77	-4.56	34.98%			
2216M	0.36	-4.6	34.68%			

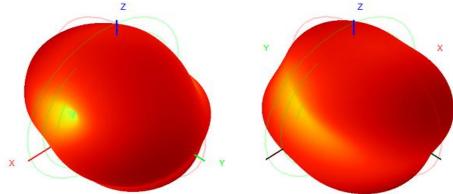
#### GPS

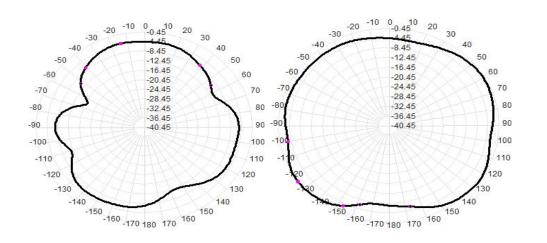
	Gain&Eff 增益和			
frequency 频率(Hz)	gain 增益(dB)	efficiency 效率(dB)	efficiency 效率 33.70%	
1550	1.15	-3.35		
1555	1.6	-3.35	34.50%	
1560	0.95	-3.34	35.60%	
1565	0.52	-3.52	36.54%	
1570	0.63	-4.30	31.41%	
1575	0.25	-0.25	33.50%	

#### WIFI&BT

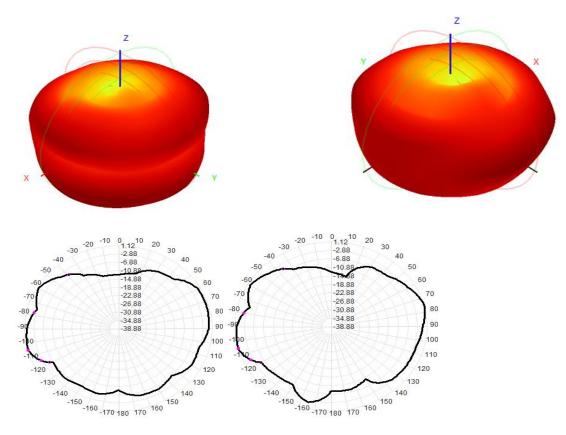
2400	1.14	-3.5	37.90%	
2420	1.30	-3	39.60%	
2440	1.05	-3.54	39.40%	
2460	0.65	-3.41	35.80%	
2480	0.24	-3.3	34.68%	
2500	0.01	-3.5	34.80%	

LTE:

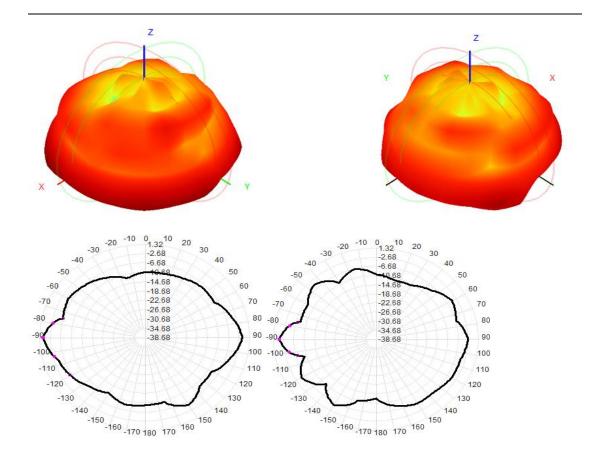




GPS:



WIFI :



# 6.Test Equipment Test system: shielded darkroom The temperature was 22 ° C ± 3 ° C and the humidity was 50% ± 15%

Test equipment: when testing passive data, use the Network analyzer AGILENTE5071C to test active data, use the omnibus CMW500









#### 7.Active antenna test data

Frequency Band		GSM;850			900		
channel	L	М	Н	L	М	Н	
TRP	27.4	27.6	28.2	28.5	28.6	27.3	
TIS			-103. 1			-102. 9	
Frequency Band	1800		1900				
channel	L	М	H	L	М	H	
TRP	24.5	23.6	23.3	25.2	25.6	25.8	
TIS			-102.4			-104. 3	

Frequency Band	WCDMA 1			WCDMA 2			
channel	L	М	Н	L	М	Н	
TRP	17.5	18.5	17.3	18.5	18.3	17.3	
TIS			-103. 1			-102.5	

Frequency Band		WCDMA 5			WCDMA 8	
channel	L	М	Н	L	М	Н
TRP	17.8	17.4	17.3	18.5	18.4	17.4
TIS			-103.9			-102.7

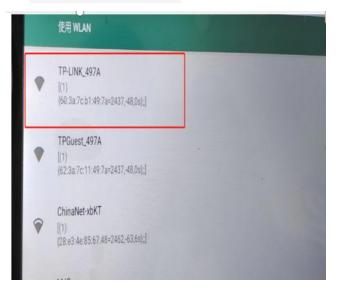
Frequency Band	LTE B1			LTE B2		
channel	L	М	H	L	М	H
TRP	17.5	18.5	19.1	18.5	17.6	16.9
TIS			-92.3			-90.5

Frequency Band		LTE B3	*	LTE B5			
channel	L	М	Н	L	М	Н	
TRP	17.7	17.5	18.2	18.9	19.3	18.4	
TIS			-91.4			-92.8	
Frequency Band		LTE B8 LTE E			LTE B12		
channel	L	М	H	L	М	Н	
TRP	18.5	17.7	17.4	15.4	15.6	15.3	
TIS			-90. 3			-88.3	

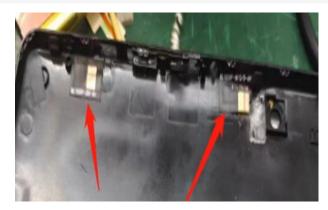
Frequency Band	LTE B17			LTE B20		
channel	L	М	Н	L	М	Н
TRP	14.8	15.2	15.3	17.4	17.2	17.3
TIS			-90.3			-92. 1
Frequency Band	LTE B28			LTE B66		
channel	L	М	Н	L	М	Н
TRP	14.8	15.3	15.2	17.8	18.4	18.3
TIS			-88.7			-90. 6

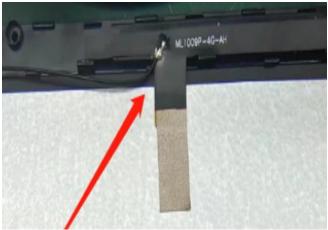
Frequency Band		[FI-2. 4G-1	3模	₩IFI-2.4G-G模			
channel	L	I	H	L	I	H	
TRP	10.25	10.31	10.25	9.54	9. 25	8. 57	
TIS			-78. 51			-68.41	
Frequency Band		₩IFI-2. 4G-N模					
channel	L	I	H				
TRP	8.54	8.65	8.23				
TIS			-65.31				

#### 7.1 Real-time WiFi results



#### 8.Schematic diagram of antenna assembly





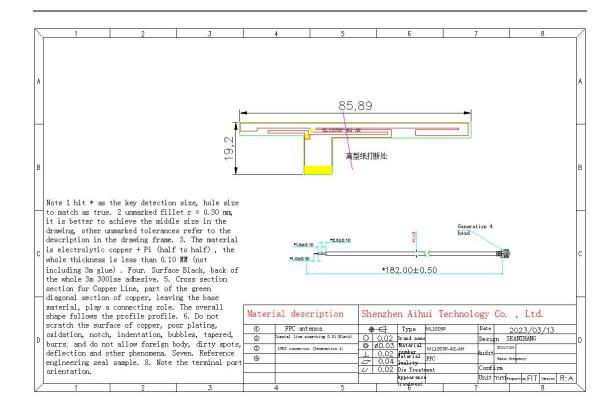
9.Antenna environment handling



10.Antenna mass production index

When the antenna is mass-produced, the standing wave ratio is taken as the mass-produced test standard. Based on the differences of the project itself, the following criteria are given:	Standard for volume production
680MHZ-2700Mhz	VSWR (Mass Production performance) & LT; VSWR(recognition performance) 0.5

# 10.1 Structural drawings



	1	2	3	4	5	6	7	8
A								A
в	Note 1 hit * as	the key detection	1 size, hole size					В
c	to match as true it is better to : drawing, other un description in th is electrolytic - whole thickness including 3m glum the whole 3m 300 section for Coppo	2 unmarked fill achieve the middl umarked tolerance to drawing frame. copper + Pi (half is less than 0.10 e) . Four. Surfac lse adhesive. 5. er Line, part of	et r = 0.30 mm, e size in the so refer to the 3. The material to half), the ) MM (not e Black, back of Cross section the green					c
D	deflection and o	connecting role. e profile profile ace of copper, po indentation, bu t allow foreign b ther phenomena. S	The overall c. 6. Do not our plating, abbles, tapered, pody, dirty spots,	Material desc	enna <del>(</del>	enzhen Aihui 1 0.02 brand name 0.03 Naterial 0.02 daterial NELOO 0.04 pasity 0.02 Die Treatment Ropearance treagaent	pp Date Design 19P-W/G/B-AH Audit Confirm	. , Ltd. <u>2023/03/13</u> <u>SEANTANG</u> areat o majastry <u>BrownapeFIT Waraa</u> R:A

$ \  \  \  \  \  \  \  \  \  \  \  \  \ $	1 2 3	4	5	6	7	8
A						ļ
В	Note 1 hit * as the key detection size, hole size	L				E
c	to match as true. 2 unmarked fillet r = 0.30 mm, it is better to achieve the middle size in the drawing, other unmarked tolerances refer to the description in the drawing frame. 3. The material is electrolytic copper + Pi (half to half), the whole thickness is less than 0.10 MM (not including 3m glue). Four. Surface Black, back of the whole 3m 3001se adhesive. 5. Cross section section for Copper Line, part of the green	( (				Ċ
D	diagonal section of copper, leaving the base material, play a connecting role. The overall shape follows the profile profile. 6. Do not scratch the surface of copper, poor plating, oxidation, notch, indentation, bubbles, tapered, burrs; and do not allow foreign body, dirty spots, deflection and other phenomena. Seven. Reference engineering seal sample. 8. Note the terminal port	Material des (U) FFC an (2) (3) (4)	tenna 🕀	40.07 Harmin	9P Date Design 09P-DIV-AH Audit	2023/03/13 SEANZHANG